

TPCP8201-VB Datasheet

Dual N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	Q _g (TYP.)
20	0.0170 at V _{GS} = 4.5 V	20	12 nC
	0.0240 at V _{GS} = 2.5 V	17	
	0.0490 at V _{GS} = 1.8 V	10	

FEATURES

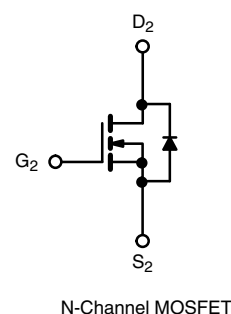
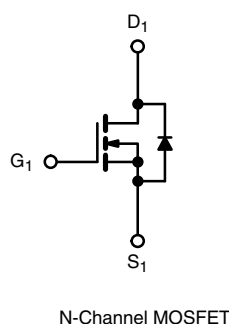
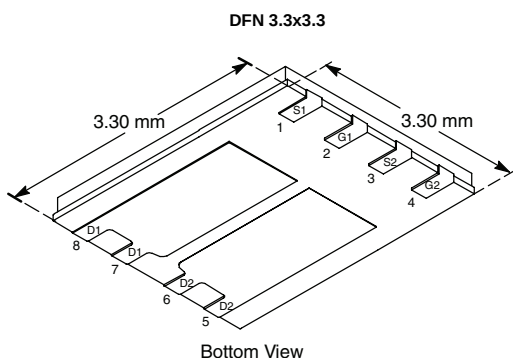
- Trench power MOSFET

APPLICATIONS

- DC/DC
- Notebook system power
- POL



RoHS
COMPLIANT
HALOGEN
FREE



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	20	V
Gate-Source Voltage		V _{GS}	± 8	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I _D	20	A
	T _C = 70 °C		15.8	
	T _A = 25 °C		8 a, b	
	T _A = 70 °C		6.5 a, b	
Pulsed Drain Current		I _{DM}	40	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	15	
	T _A = 25 °C		2.2 a, b	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15	mJ
Single Pulse Avalanche Energy		E _{AS}	11	
Maximum Power Dissipation	T _C = 25 °C	P _D	20	W
	T _C = 70 °C		12.8	
	T _A = 25 °C		2.5 a, b	
	T _A = 70 °C		1.6 ^{a, b}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C
Soldering Recommendations (Peak Temperature) ^{c, d}			260	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM
Maximum Junction-to-Ambient	t ≤ 10 s	R _{thJA}	38	48
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.3	5.4

Notes

- Package limited, T_C = 25 °C.
- Surface Mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under Steady State conditions is 110 °C/W.

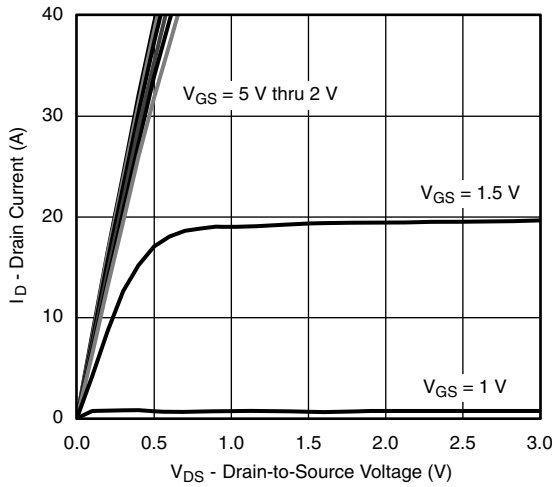
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	20	-	-	V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA	-	22	-	mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J		-	-3	-	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.4	-	1	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 8 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C	-	-	10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	20	-	-	A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A	-	0.0170	-	Ω
		V _{GS} = 2.5 V, I _D = 9 A	-	0.0240	-	
		V _{GS} = 1.8 V, I _D = 8.2 A	-	0.0490	-	
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 10 A	-	47	-	S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	-	1120	-	pF
Output Capacitance	C _{oss}		-	180	-	
Reverse Transfer Capacitance	C _{rss}		-	80	-	
Total Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 8 V, I _D = 10 A	-	21	32	nC
		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 10 A	-	12	18	
Gate-Source Charge	Q _{gs}		-	2	-	
Gate-Drain Charge	Q _{gd}		-	1.3	-	
Gate Resistance	R _g	f = 1 MHz	-	1.8	3.6	Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = 10 V, R _L = 1.25 Ω I _D ≅ 8 A, V _{GEN} = 4.5 V, R _g = 1 Ω	-	10	15	ns
Rise Time	t _r		-	10	15	
Turn-Off Delay Time	t _{d(off)}		-	35	55	
Fall Time	t _f		-	10	15	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 10 V, R _L = 1.25 Ω I _D ≅ 8 A, V _{GEN} = 8 V, R _g = 1 Ω	-	10	15	
Rise Time	t _r		-	10	15	
Turn-Off Delay Time	t _{d(off)}		-	25	40	
Fall Time	t _f		-	10	15	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	19	A
Pulse Diode Forward Current	I _{SM}		-	-	40	
Body Diode Voltage	V _{SD}	I _S = 8 A, V _{GS} = 0 V	-	0.81	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 8 A, dI/dt = 100 A/μs, T _J = 25 °C	-	20	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	15	25	nC
Reverse Recovery Fall Time	t _a		-	12.5	-	ns
Reverse Recovery Rise Time	t _b		-	7.5	-	

Notes

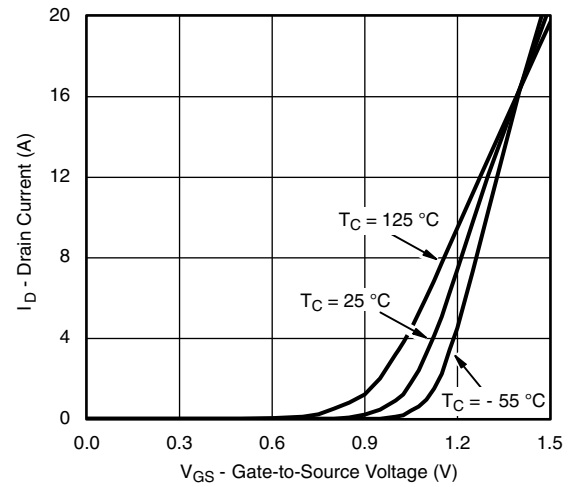
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

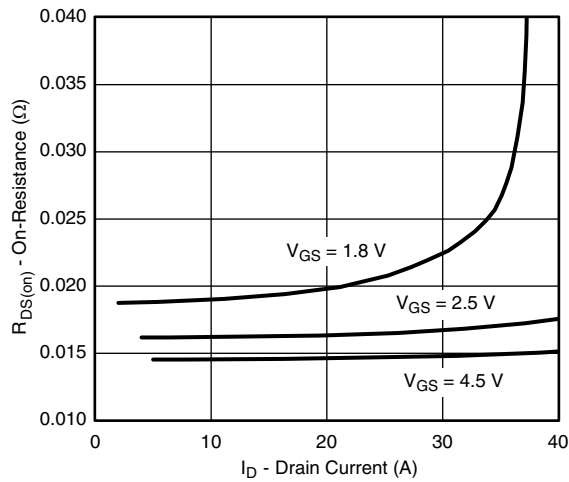
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



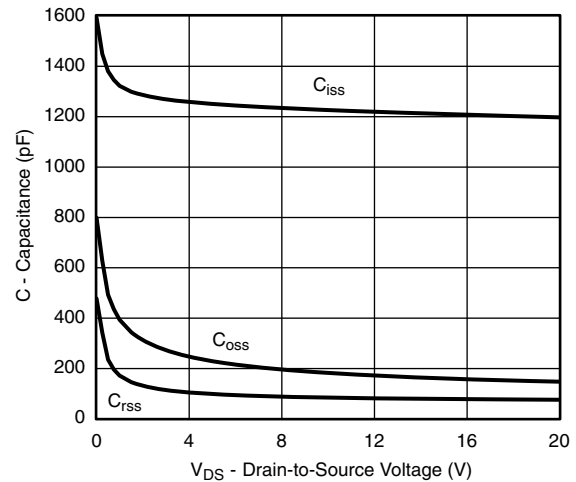
Output Characteristics



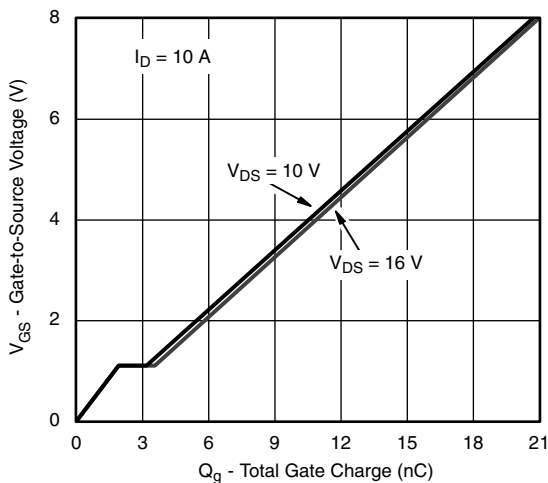
Transfer Characteristics



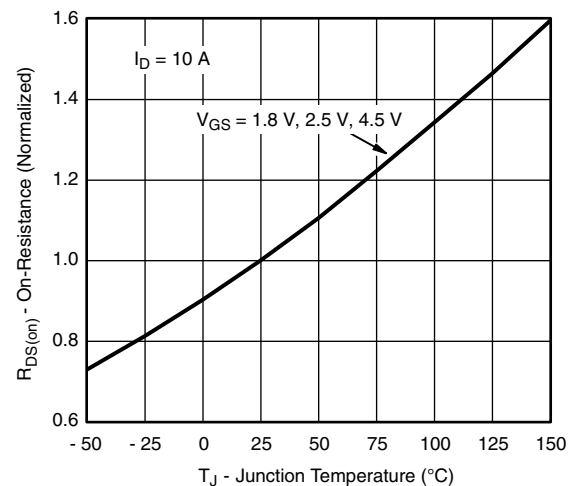
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

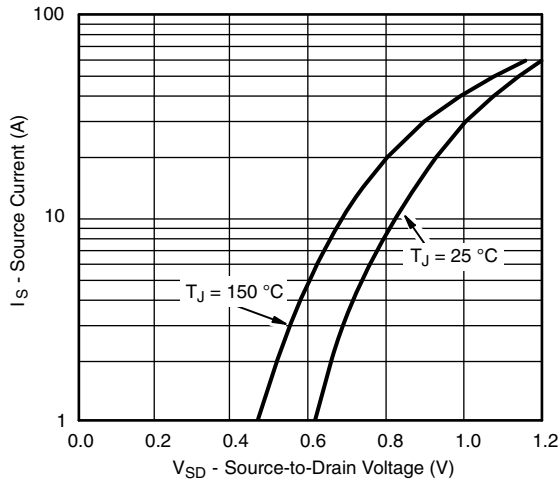


Gate Charge

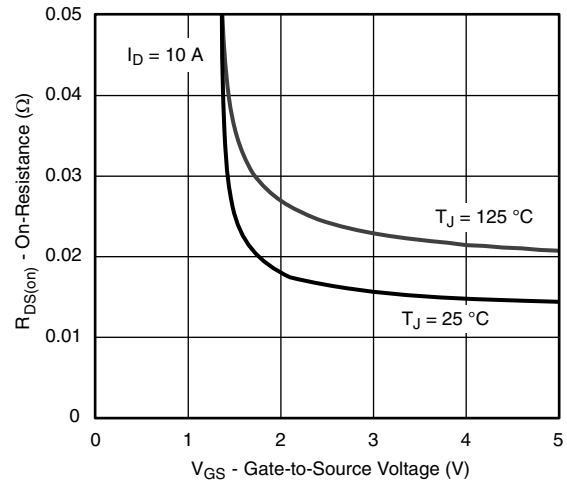


On-Resistance vs. Junction Temperature

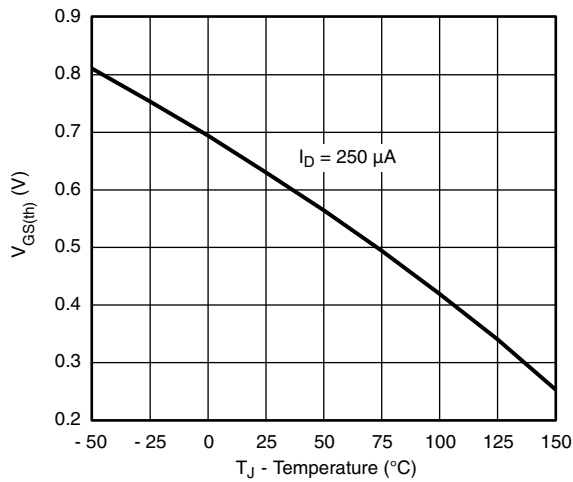
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



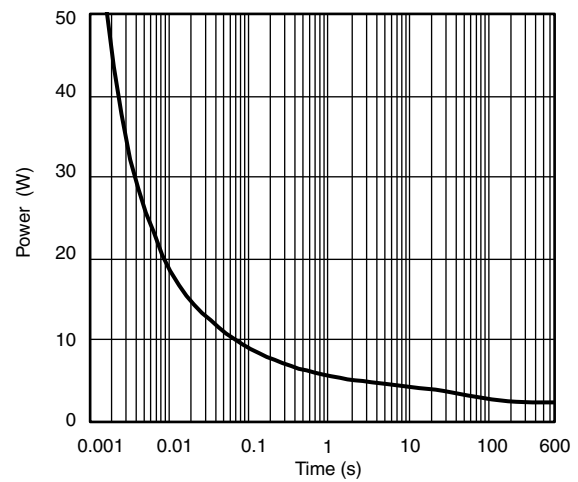
Source-Drain Diode Forward Voltage



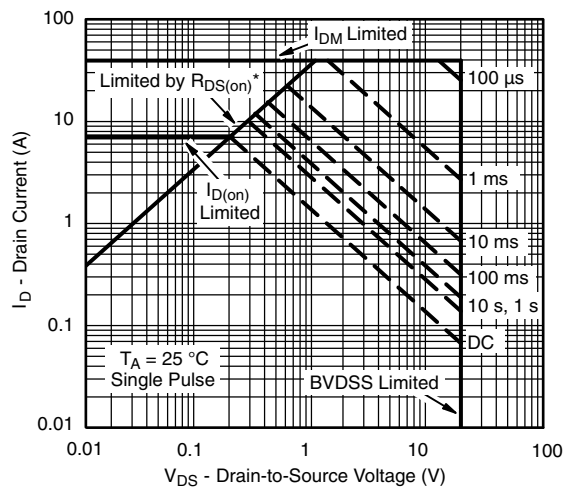
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



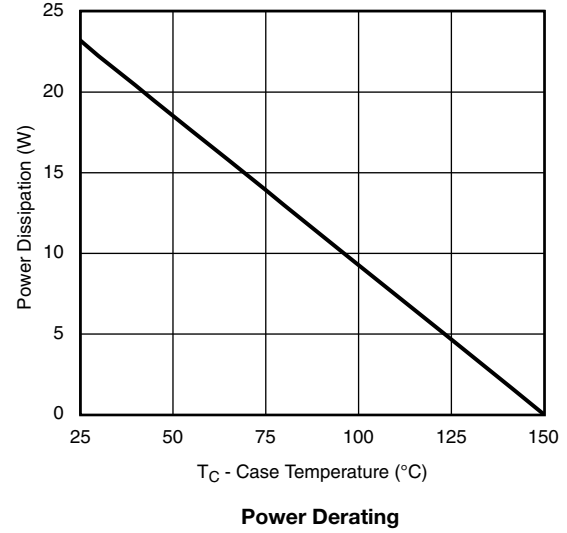
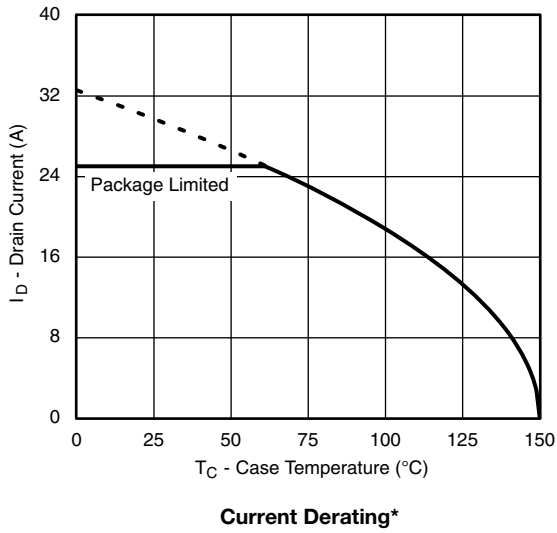
Single Pulse Power, Junction-to-Ambient



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

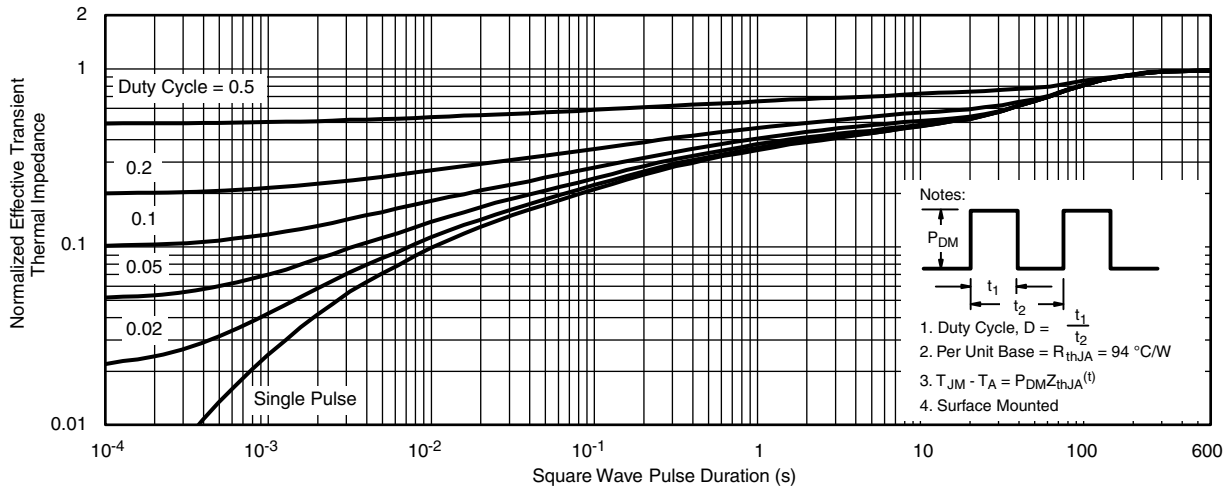
Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on T_J (max.) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

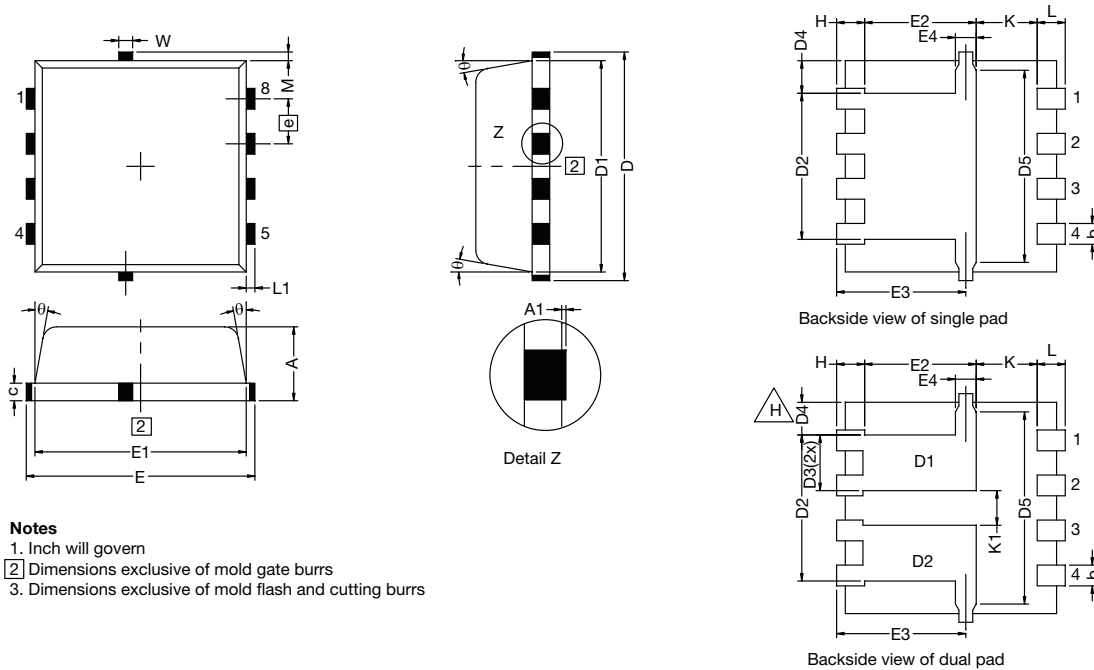


Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

DFN3.3X3.3 (Dual)



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.97	1.04	1.12	0.038	0.041	0.044
A1	0.00	-	0.05	0.000	-	0.002
b	0.23	0.30	0.41	0.009	0.012	0.016
c	0.23	0.28	0.33	0.009	0.011	0.013
D	3.20	3.30	3.40	0.126	0.130	0.134
D1	2.95	3.05	3.15	0.116	0.120	0.124
D2	1.98	2.11	2.24	0.078	0.083	0.088
D3	0.48	-	0.89	0.019	-	0.035
D4	0.47 typ.			0.0185 typ		
D5	2.3 typ.			0.090 typ		
E	3.20	3.30	3.40	0.126	0.130	0.134
E1	2.95	3.05	3.15	0.116	0.120	0.124
E2	1.47	1.60	1.73	0.058	0.063	0.068
E3	1.75	1.85	1.98	0.069	0.073	0.078
E4	0.034 typ.			0.013 typ.		
e	0.65 BSC			0.026 BSC		
K	0.86 typ.			0.034 typ.		
K1	0.35	-	-	0.014	-	-
H	0.30	0.41	0.51	0.012	0.016	0.020
L	0.30	0.43	0.56	0.012	0.017	0.022
L1	0.06	0.13	0.20	0.002	0.005	0.008
θ	0°	-	12°	0°	-	12°
W	0.15	0.25	0.36	0.006	0.010	0.014
M	0.125 typ.			0.005 typ.		
ECN: S16-2667-Rev. M, 09-Jan-17						
DWG: 5882						

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